

## Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- One BAV70 Circuit and One BAW56 Circuit In One Package
- **Lead Free/RoHS Compliant (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **"Green" Device (Notes 4 and 5)**

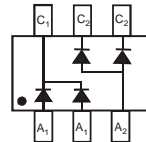
## Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)



TOP VIEW

SOT-363


 TOP VIEW  
Internal Schematic

## Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic   | Symbol       | Value | Unit |
|--|--------------|-------|------|
| Non-Repetitive Peak Reverse Voltage                              | $V_{RM}$     | 100   | V    |
| Peak Repetitive Reverse Voltage                                  | $V_{RRM}$    | 75    | V    |
| Working Peak Reverse Voltage                                     | $V_{RWM}$    |       |      |
| DC Blocking Voltage  | $V_R$        |       |      |
| RMS Reverse Voltage  | $V_{R(RMS)}$ | 53    | V    |
| Forward Continuous Current (Note 1)                              | $I_{FM}$     | 300   | mA   |
| Average Rectified Output Current (Note 1)                        | $I_O$        | 150   | mA   |
| Non-Repetitive Peak Forward Surge Current @ $t = 1.0\mu\text{s}$ | $I_{FSM}$    | 2.0   | A    |
| @ $t = 1.0\text{s}$  |              | 1.0   |      |

## Thermal Characteristics

| Characteristic                                      | Symbol          | Value       | Unit               |
|---|-----------------|-------------|--------------------|
| Power Dissipation (Note 1)                          | $P_D$           | 200         | mW                 |
| Thermal Resistance Junction to Ambient Air (Note 1) | $R_{\theta JA}$ | 625         | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range             | $T_J, T_{STG}$  | -65 to +150 | $^\circ\text{C}$   |

## Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic                     | Symbol      | Min | Max   | Unit          | Test Condition  |
|------------------------------------|-------------|-----|-------|---------------|---|
| Reverse Breakdown Voltage (Note 2) | $V_{(BR)R}$ | 75  | —     | V             | $I_R = 2.5\mu\text{A}$  |
| Forward Voltage                    | $V_F$       | —   | 0.715 | V             | $I_F = 1.0\text{mA}$  |
|                                    |             |     | 0.855 |               | $I_F = 10\text{mA}$   |
|                                    |             |     | 1.0   |               | $I_F = 50\text{mA}$   |
|                                    |             |     | 1.25  |               | $I_F = 150\text{mA}$  |
| Reverse Current (Note 2)           | $I_R$       | —   | 2.5   | $\mu\text{A}$ | $V_R = 75\text{V}$  |
|                                    |             |     | 50    | $\mu\text{A}$ | $V_R = 75\text{V}, T_J = 150^\circ\text{C}$                               |
|                                    |             |     | 30    | $\mu\text{A}$ | $V_R = 25\text{V}, T_J = 150^\circ\text{C}$                               |
|                                    |             |     | 25    | nA            | $V_R = 20\text{V}$  |
| Total Capacitance                  | $C_T$       | —   | 2.0   | pF            | $V_R = 0, f = 1.0\text{MHz}$  |
| Reverse Recovery Time              | $t_{rr}$    | —   | 4.0   | ns            | $I_F = I_R = 10\text{mA}$ ,<br>$I_{rr} = 0.1 \times I_R, R_L = 100\Omega$ |

- Notes:
1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. Short duration pulse test used to minimize self-heating effect.
  3. No purposefully added lead.
  4. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  5. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

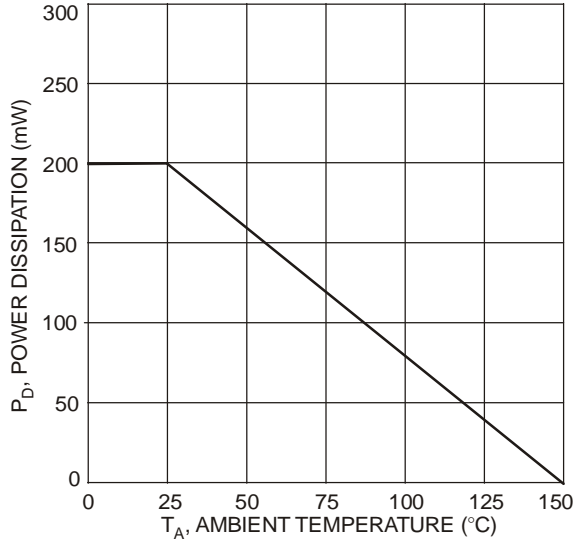


Fig. 1 Power Derating Curve, Total Package

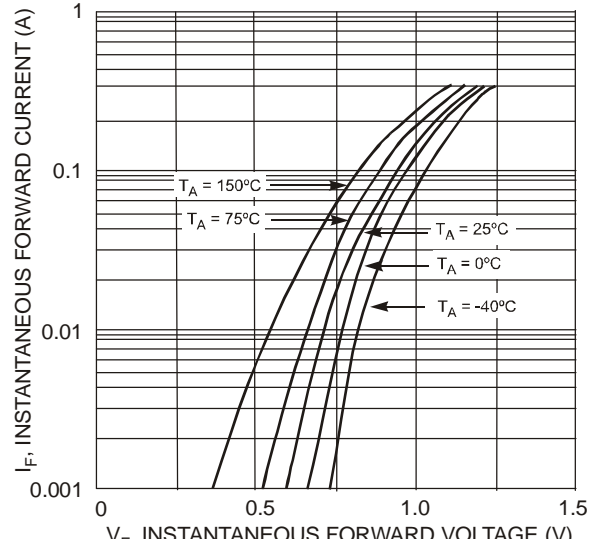


Fig. 2 Typical Forward Characteristics, Per Element

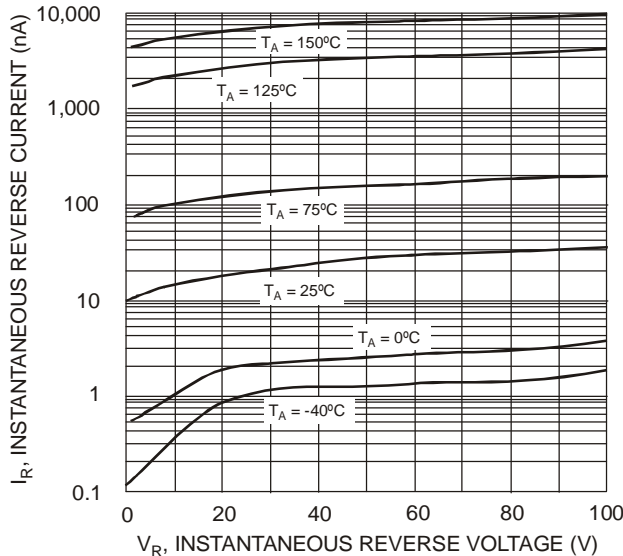


Fig. 3 Typical Reverse Characteristics, Per Element

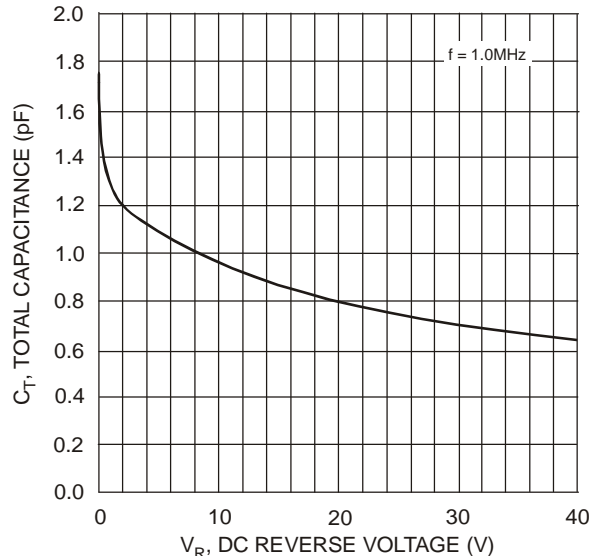


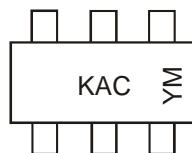
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

**Ordering Information** (Note 6)

| Part Number  | Case    | Packaging        |
|--------------|---------|------------------|
| BAW567DW-7-F | SOT-363 | 3000/Tape & Reel |

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**

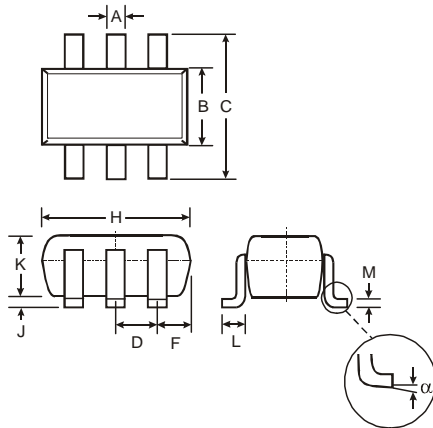


KAC = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year ex: N = 2002  
 M = Month ex: 9 = September

Date Code Key

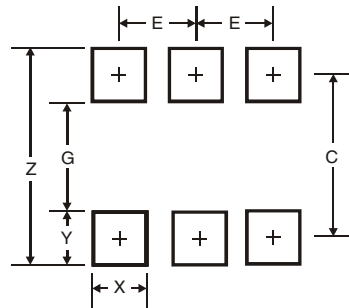
| Year  | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code  | M    | N    | P    | R    | S    | T    | U    | V    | W    | X    | Y    | Z    |
| Month | Jan  | Feb  | Mar  | Apr  | May  | Jun  | Jul  | Aug  | Sep  | Oct  | Nov  | Dec  |
| Code  | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | O    | N    | D    |

**Package Outline Dimensions**



| SOT-363                     |              |      |
|-----------------------------|--------------|------|
| Dim                         | Min          | Max  |
| A                           | 0.10         | 0.30 |
| B                           | 1.15         | 1.35 |
| C                           | 2.00         | 2.20 |
| D                           | 0.65 Nominal |      |
| F                           | 0.30         | 0.40 |
| H                           | 1.80         | 2.20 |
| J                           | —            | 0.10 |
| K                           | 0.90         | 1.00 |
| L                           | 0.25         | 0.40 |
| M                           | 0.10         | 0.25 |
| α                           | 0°           | 8°   |
| <b>All Dimensions in mm</b> |              |      |

**Suggested Pad Layout**



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.5           |
| G          | 1.3           |
| X          | 0.42          |
| Y          | 0.6           |
| C          | 1.9           |
| E          | 0.65          |

**IMPORTANT NOTICE**

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

**LIFE SUPPORT**

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.